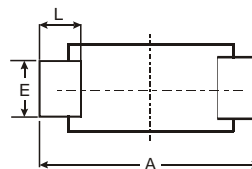
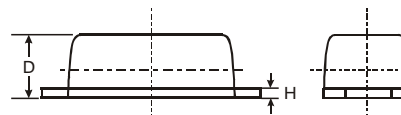
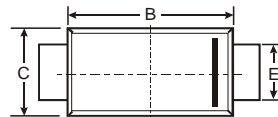
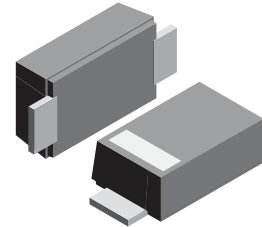


VOLTAGE RANGE: 50 - 1000V

CURRENT: 1.0 A

Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Voltage Drop, High Efficiency
- Low Power Loss
- Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O



| SMAF | | | |
|----------------------|-------|------|------|
| Dim | Min | Max | Typ |
| A | 4.75 | 4.85 | 4.80 |
| B | 3.68 | 3.72 | 3.70 |
| C | 2.57 | 2.63 | 2.60 |
| D | 0.097 | 1.03 | 1.00 |
| E | 1.38 | 1.42 | 1.40 |
| H | 0.13 | 0.17 | 0.15 |
| L | 0.63 | 0.67 | 0.65 |
| All Dimensions in mm | | | |

Mechanical Data

- Case: SMAF, Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Weight: 0.0018 ounce, 0.064 grams



Maximum Ratings and Electrical Characteristics T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | FR1AF | FR1BF | FR1DF | FR1GF | FR1JF | FR1KF | FR1MF | Unit |
|--|-----------------------------------|-------------|-------|-------|-------|-------|-------|-------|------|
| Maximum Recurrent Peak Reverse Voltage | V _{RRM} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum RMS Voltage | V _{RMS} | 35 | 70 | 140 | 280 | 420 | 560 | 700 | V |
| Maximum DC Blocking Voltage | V _{DC} | 50 | 100 | 200 | 400 | 600 | 800 | 1000 | V |
| Maximum Average Forward Rectified Current @ T _A = 75°C | I _(AV) | 1.0 | | | | | | | A |
| Peak Forward Surge Current 8.3 ms single half sine-wave superimposed on rated load (JEDEC Method) | I _{FSM} | 30 | | | | | | | A |
| Maximum Instantaneous Forward Voltage at 1.0 A | V _F | 1.3 | | | | | | | V |
| Maximum DC Reverse Current at Rated DC Blocking Voltage @ T _A = 25°C @ T _A = 125°C | I _R | 5.0 100 | | | | | | | μA |
| Maximum Full Load Reverse Current Full Cycle Average @ T _A = 75°C | | 50 | | | | | | | μA |
| Maximum Reverse Recovery Time (See Note 1) | t _{rr} | 150 | | | | 250 | 500 | 500 | ns |
| Maximum Thermal Resistance (See Note 2) | R _{θJL} | 30 | | | | | | | °C/W |
| Typical Junction Capacitance (See Note 3) | C _J | 15 | | | | | | | pF |
| Operating and Storage Temperature Rating | T _J , T _{STG} | -65 to +175 | | | | | | | °C |

- Notes:
1. Reverse Recovery Test Conditions: I_F = 0.5A, I_R = 1A, I_{RR} = 0.25A
 2. Thermal Resistance from junction to lead with 6.0mm² copper pads
 3. Measured at 1.0MHz and applied reverse voltage of 4.0V

RATINGS AND CHARACTERISTIC CURVES FR1AF THRU FR1MF

AVERAGE FORWARD RECTIFIED CURRENT,
AMPERES

FIG. 1- FORWARD CURRENT DERATING CURVE

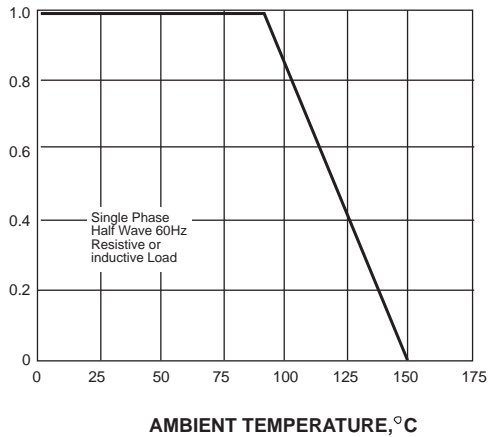


FIG. 2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

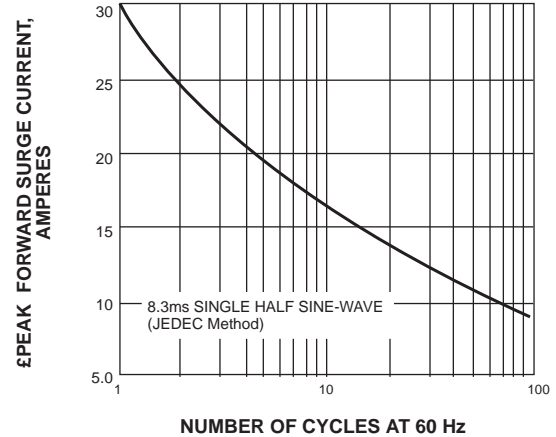


FIG. 3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

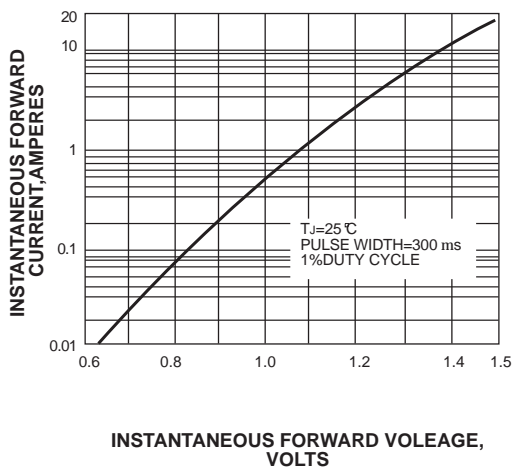


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

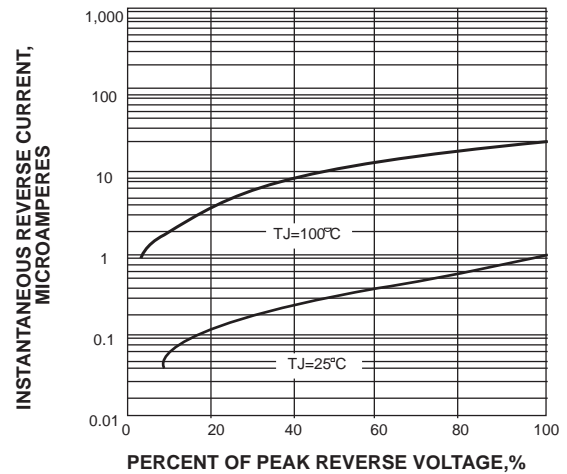


FIG. 5-TYPICAL JUNCTION CAPACITANCE

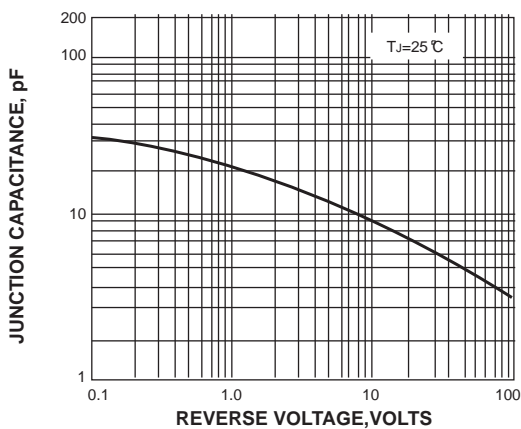


FIG. 6-TYPICAL TRANSIENT THERMAL IMPEDANCE

